

MECHANICAL CASE OUTLINE

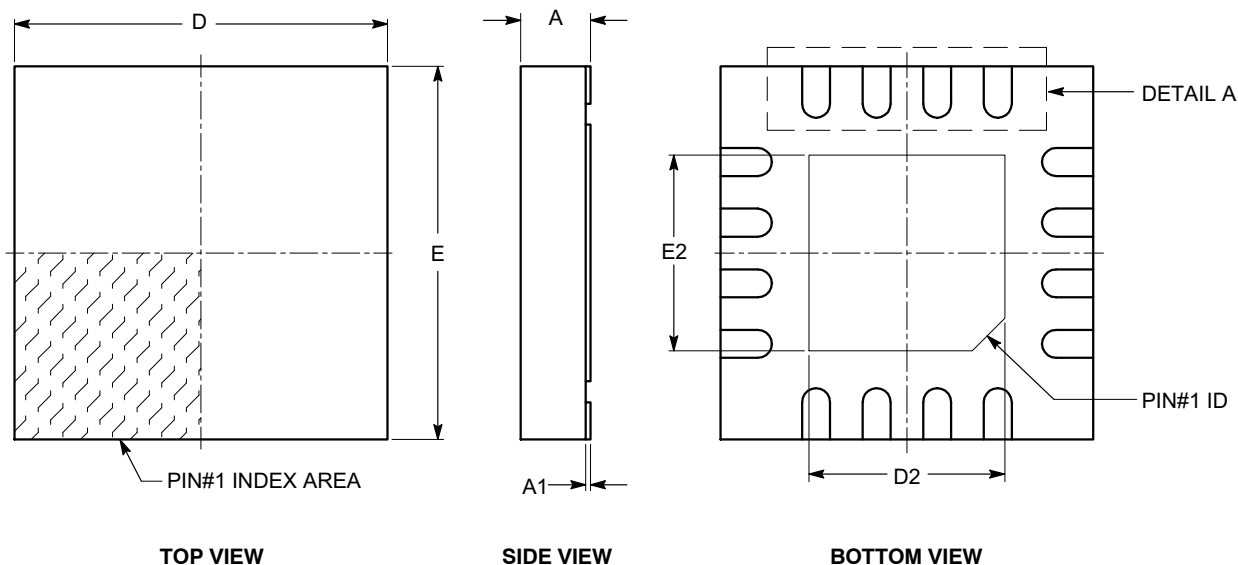
PACKAGE DIMENSIONS

ON Semiconductor®



TQFN16, 4x4
CASE 510AE-01
ISSUE A

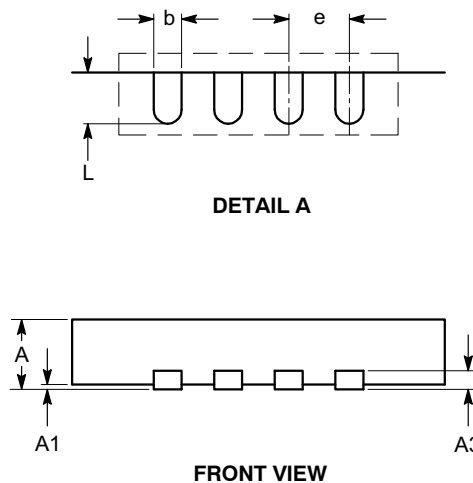
DATE 18 MAR 2009



SYMBOL	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	0.20 REF		
b	0.25	0.30	0.35
D	3.90	4.00	4.10
D2	2.00	---	2.25
E	3.90	4.00	4.10
E2	2.00	---	2.25
e	0.65 BSC		
L	0.45	---	0.65

Notes:

- (1) All dimensions are in millimeters.
- (2) Complies with JEDEC MO-220.



DOCUMENT NUMBER:	98AON34374E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
STATUS:	ON SEMICONDUCTOR STANDARD	
REFERENCE:		
DESCRIPTION:	TQFN16, 4X4	PAGE 1 OF 2

